SDLS088

DECEMBER 1983 – REVISED MARCH 1988

FOR SYMMETRICAL GENERATION OF COMPLEMENTARY TTL SIGNALS

- **Switching Time Skew of the Complementary Outputs Is Typically 0.5 ns . . . Not More than 3 ns at Rated Loading**
- **Full Fan-Out to 20 High-Level and 10 Low-Level 54/74 Loads**
- **Active Pull-Down Provides Square Transfer Characteristics**

description

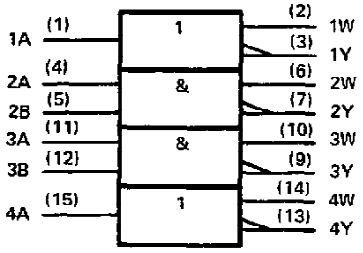
The SN54265 and SN74265 circuits feature complementary outputs from each logic element, which have virtually symmetrical switching time delays from the triggering input. They are designed specifically for use in applications such as:

- Symmetrical clock/$\overline{\text{clock}}$ generators
- Complementary input circuit for decoders and code converters
- Switch debouncing
- Differential line driver

Examples of these four functions are illustrated in the typical application data.

The SN54265 is characterized for operation over the full military temperature range of −55°C to 125°C; the SN74265 is characterized for operation from 0°C to 70°C.

logic symbol†



†This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

logic diagrams

ELEMENTS 1 and 4

ELEMENTS 2 and 3

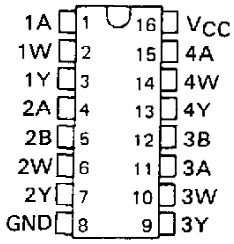
positive logic

$Y = \overline{A}$ $W = A$

$Y = \overline{AB}$ or $Y = \overline{A} + \overline{B}$

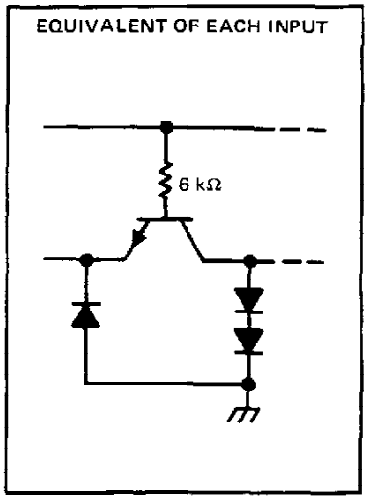
$W = AB$ or $W = \overline{\overline{A} + \overline{B}}$

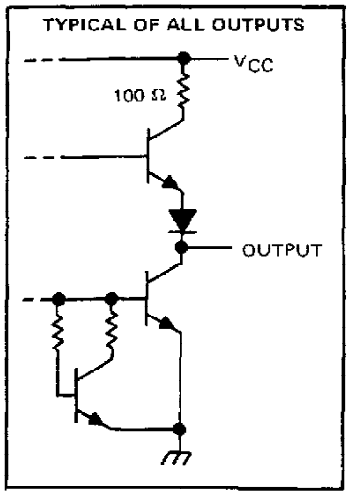
SN54265 . . . J OR W PACKAGE
SN74265 . . . N PACKAGE
(TOP VIEW)



NC No internal connection

schematics of inputs and outputs





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 5.5 V
Operating free-air temperature range: SN54265 . . . . . −55°C to 125°C
SN74265 . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1. Voltage values are with respect to network ground terminal.

recommended operating conditions

	SN54265			SN74265			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−800			−800	μA
Low-level output current, I_{OL}			16			16	mA
Operating free-air temperature, T_A	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		MIN	TYP‡	MAX	UNIT
V_{IH}	High-level input voltage			2			V
V_{IL}	Low-level input voltage					0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN,	I_I = −12 mA			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN,	I_{OH} = −800 μA	2.4	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN,	I_{OL} = 16 mA		0.2	0.4	V
I_I	Input current at maximum input voltage	V_{CC} = MAX,	V_I = 5.5 V			1	mA
I_{IH}	High-level input current	V_{CC} = MAX,	V_I = 2.4 V			40	μA
I_{IL}	Low-level input current	V_{CC} = MAX,	V_I = 0.4 V			−1.6	mA
I_{OS}	Short-circuit output current§	V_{CC} = MAX,	SN54265	−20		−57	mA
			SN74265	−18		−57	
I_{CC}	Supply current	V_{CC} = MAX,	See Note 2		25	34	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time.
NOTE 2: I_{CC} is measured with all outputs open and all inputs grounded.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{PLH(W)}$	A or B (as applicable)	W	R_L = 400 Ω, C_L = 15 pF, See Note 3		11.6	18	ns
$t_{PHL(Y)}$		Y			11.3	18	
$t_{PHL(W)}$	A or B (as applicable)	W			9.8	18	ns
$t_{PLH(Y)}$		Y			10.2	18	
$t_{PLH(W)}-t_{PHL(Y)}$	A or B (as applicable)	W with respect to Y			+0.3	±3	ns
$t_{PHL(W)}-t_{PLH(Y)}$					−0.4	±3	

t_{PLH} = propagation delay time, low-to-high-level output
t_{PHL} = propagation delay time, high-to-low-level output
$t_{PXX(W)}-t_{PXX(Y)}$ = Difference in indicated propagation delay times at the W and Y outputs, respectively.
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

TYPICAL CHARACTERISTICS†

PROPAGATION DELAY TIME DIFFERENCE
vs
FREE-AIR TEMPERATURE

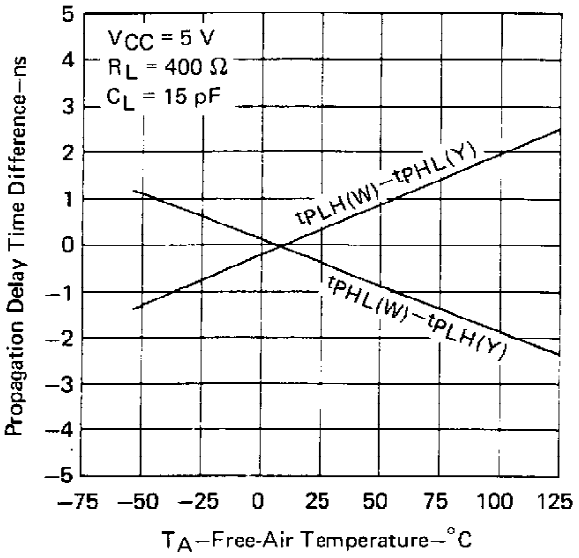


FIGURE 1

PROPAGATION DELAY TIME DIFFERENCE
vs
SUPPLY VOLTAGE

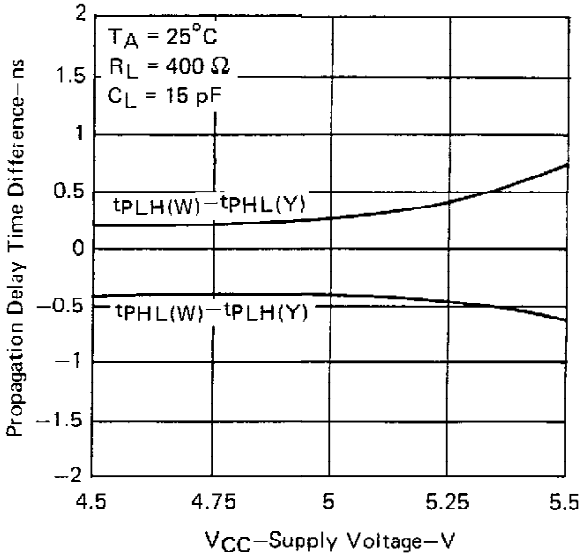


FIGURE 2

PROPAGATION DELAY TIME DIFFERENCE vs LOAD CAPACITANCE

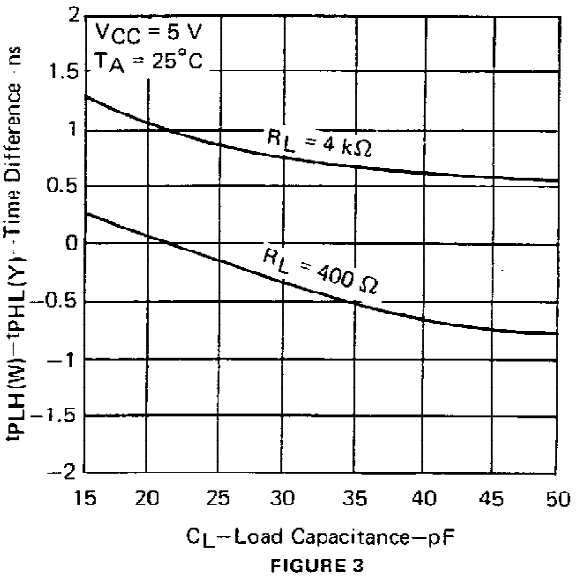


FIGURE 3

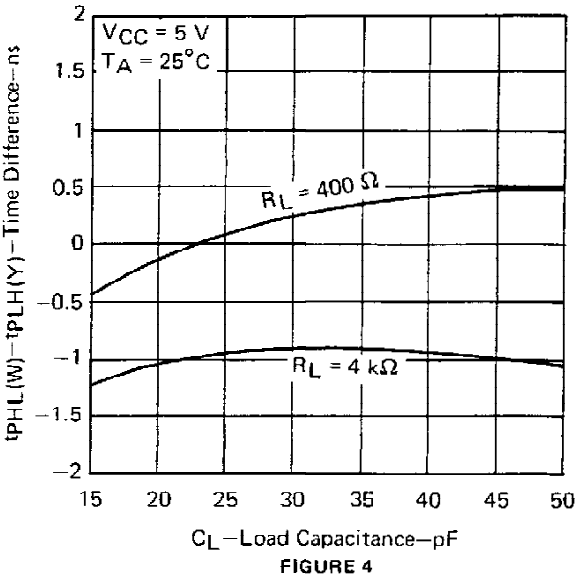


FIGURE 4

†Data for temperatures below 0°C and above 70°C and for supply voltages below 4.75 V and above 5.25 V are applicable for SN54265 only.

TYPICAL APPLICATION DATA

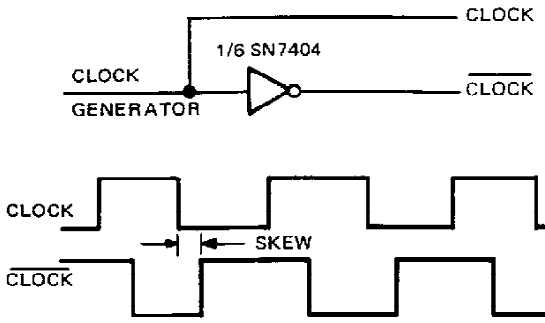


FIGURE A – TYPICAL CLOCK/$\overline{\text{CLOCK}}$ GENERATOR CIRCUIT

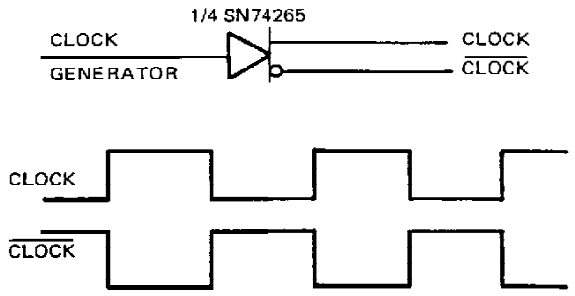


FIGURE B – SKEWLESS CLOCK/$\overline{\text{CLOCK}}$ GENERATOR CIRCUIT

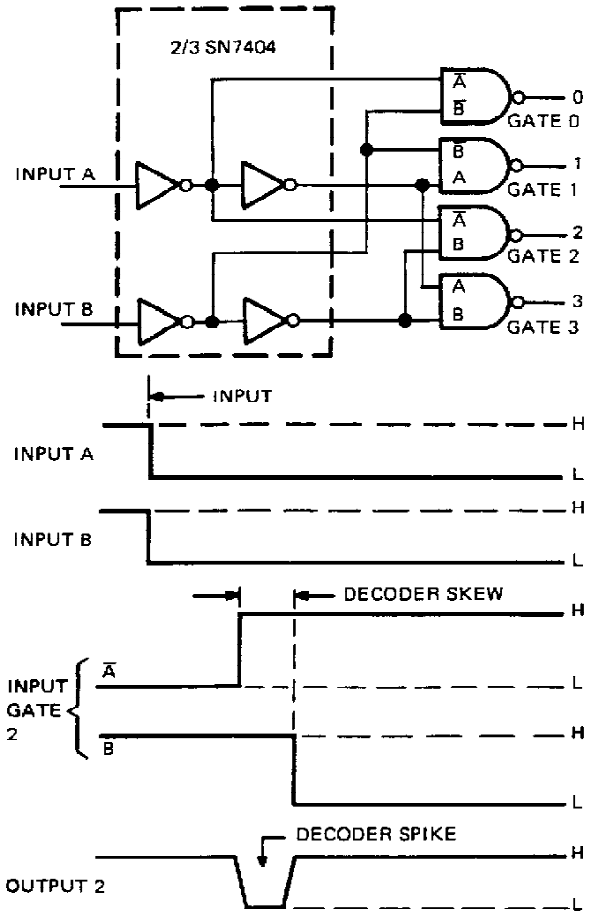


FIGURE C – TYPICAL DECODER/CODE CONVERTER

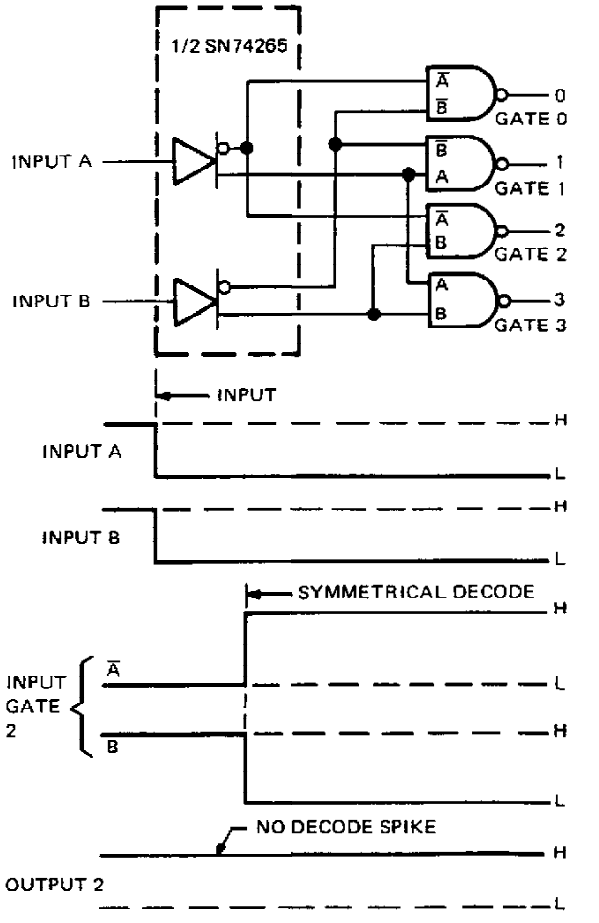


FIGURE D – SYMMETRICAL DECODER/CODE CONVERTER

TYPICAL APPLICATION DATA

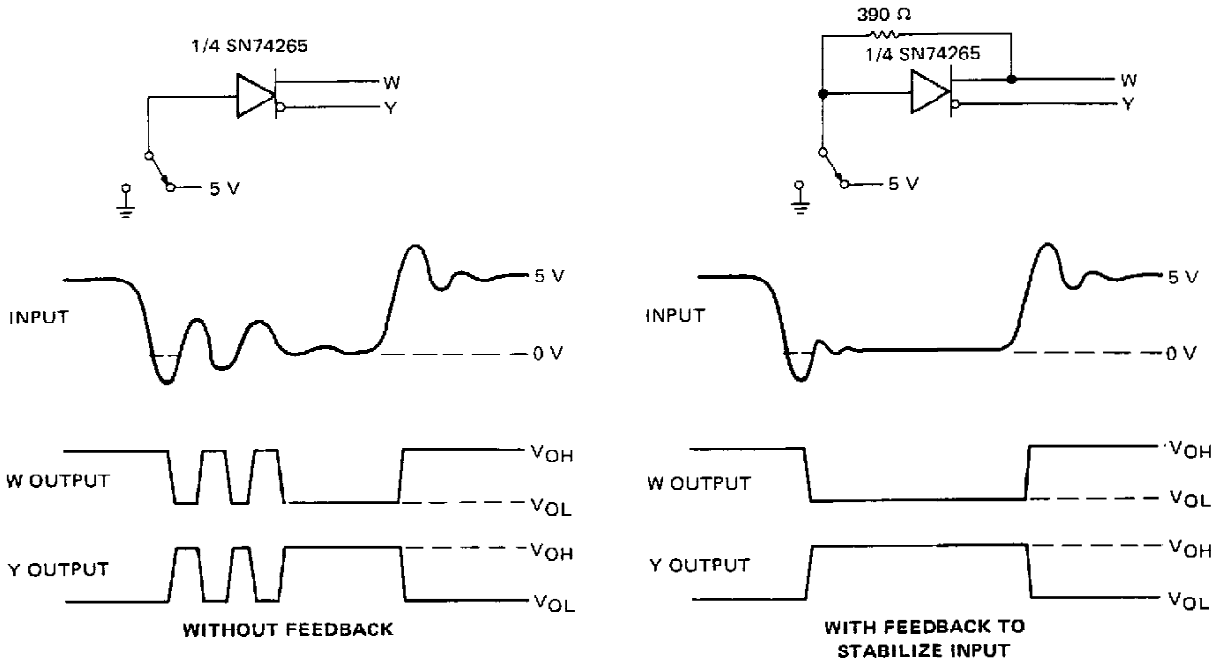
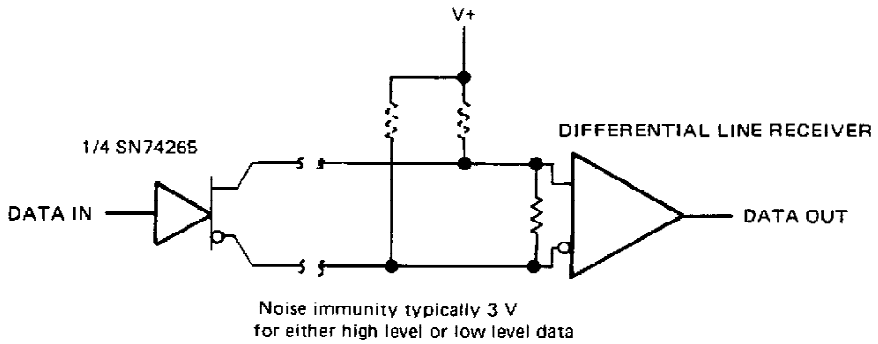


FIGURE E – SWITCH DEBOUNCER



Noise immunity typically 3 V
for either high level or low level data

FIGURE F – DIFFERENTIAL LINE DRIVER

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